

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	1564	29/603.07,603.11,603.13-603.17,417.ccls.	USPAT; JPO; DERWENT	OR	ON	2004/05/26 11:41
S2	3493	360/121,123,126,317,235.7,235.8,236.3,236.5,236.6,237.ccls.	USPAT; JPO; DERWENT	OR	ON	2004/05/26 11:42
S3	3998	wafer with (slider or transducer or (magnetic adj head))	USPAT; JPO; DERWENT	OR	ON	2004/05/26 13:00
S4	1141	wafer with metalliz\$4	USPAT; JPO; DERWENT	OR	ON	2004/05/26 11:43
S5	43	(wafer with (slider or transducer or (magnetic adj head))) and (wafer with metalliz\$4)	USPAT; JPO; DERWENT	OR	ON	2005/03/01 12:48
S6	2285	wafer with (slider or (magnetic adj head))	USPAT; JPO; DERWENT	OR	ON	2004/05/26 11:56
S7	3	(wafer with metalliz\$4) and (wafer with (slider or (magnetic adj head)))	USPAT; JPO; DERWENT	OR	ON	2004/05/26 12:02
S8	240	360/121,123,126,317,235.7,235.8,236.3,236.5,236.6,237.ccls. and (wafer with (slider or (magnetic adj head)))	USPAT; JPO; DERWENT	OR	ON	2004/05/26 12:10
S9	1569	29/603.07,603.11,603.13-603.17,417.ccls.	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:08
S10	228	360/235.4,234.3,236.5,294.7.ccls.	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:06
S11	2430	216/39,41,48.ccls.	USPAT; JPO; DERWENT	OR	ON	2004/06/15 15:59
S12	3288	451/5,41.ccls.	USPAT; JPO; DERWENT	OR	ON	2004/06/15 16:00
S15	2079	29/25.35.ccls.	USPAT; JPO; DERWENT	OR	ON	2004/06/15 16:00
S18	1	"4277712".PN.	USPAT	OR	ON	2004/06/15 16:05
S19	2	"5920523".URPN.	USPAT	OR	ON	2004/06/15 16:05
S20	7	("4551647" "4641153" "4819014" "4937597" "5057664" "5072240" "5210455").PN.	USPAT	OR	ON	2004/06/15 16:07

S53	22	silicon adj slider	USPAT; JPO; DERWENT	OR	ON	2005/03/01 12:48
S54	77	wafer with silicon with slider	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:03
S55	88	S53 or S54	USPAT; JPO; DERWENT	OR	ON	2005/03/01 12:50
S56	19	S55 and carbide	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:02
S57	21	("4549238" "5034828" "5067037" "5083365" "5229193" "5301077" "5413850" "5508861" "5587857" "5617273" "5625512" "5661618" "5708540" "5712747" "5748408" "5761001" "5761790" "5781376" "5896244" "6038101" "6330131").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/01 12:58
S58	11	("5184393" "5215608" "5359479" "5421943" "5559051" "5587857" "5712747" "5734519" "5757591" "5771571" "5867888").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/01 12:54
S59	11	("4403238" "4646128" "4809103" "4881144" "5014145" "5025304" "5055969" "5168078" "5278712" "5279991" "5528819").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/01 12:56
S60	19	("5712747").URPN.	USPAT	OR	ON	2005/03/01 12:57
S61	16	S57 and carbide	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:01
S62	9	S53 and carbide	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:02
S63	3	wafer with silicon with slider with trench\$2	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:04
S64	38	fill\$3 with trench\$2 with carbide	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:05
S65	1	S53 and S64	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:04
S66	129	slider with trench\$2	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:04

S67	1	S64 and S66	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:04
S68	2343	fill\$3 with trench\$2 with (carbide or nitride)	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:49
S69	1	S66 and S68	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:05
S70	0	fill\$3 with trench\$2 with (carbide or nitride) with slider	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:05
S71	0	fill\$3 with trench\$2 with (carbide or nitride) same slider	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:05
S72	0	360/235.4,234.3,236.5,294.7.ccls. with slider	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:06
S73	233	360/235.4,234.3,236.5,294.7.ccls.	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:06
S74	188	S73 and slider	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:10
S75	0	S68 and S74	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:06
S76	2	S68 and slider	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:10
S77	385	29/603.07,603.11,603.13-603.17, 417.ccls. and slider	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:08
S78	0	S68 and S77	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:08
S79	8003	trench\$2 with (carbide or nitride)	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:08
S80	1	S77 and S79	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:09
S81	0	S73 and S79	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:09
S82	233	S73 and "360"/\$.ccls.	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:09

S83	188	S82 and slider	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:42
S84	8	S79 and slider	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:10
S85	10	lille-jeffrey-s.in.	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:12
S86	1	S79 and S85	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:13
S87	3	S66 and S85	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:13
S88	10	("4582632" "5400192" "5711063" "5783326" "5793571" "5825590" "5894655" "6005750" "6245313" "6359752").PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/01 13:14
S89	12	slider with (trench\$2 or hole or gap) with (carbide or nitride)	US-PGPUB; USPAT; USOCR	OR	ON	2005/03/01 13:15
S90	34	slider with (fill\$3 or coat\$3) with (carbide or nitride)	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:39
S91	24	S90 and @ad<"19990820"	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:25
S92	9	S90 and @ad>"19990820"	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:24
S93	11	216/65.ccls. and etch\$3 and slider	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:40
S94	0	S79 and S93	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:40
S95	5483	etch\$3 with wafer with (trench\$3 or gap or hole)	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:41
S96	3887	fill\$3 with (trench\$2 or hole or gap) with (carbide or nitride)	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:41
S97	4582	(fill\$3 or coat\$3) with (trench\$2 or hole or gap) with (carbide or nitride)	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:42

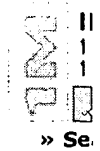
S98	421	S95 and S97	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:42
S99	2	S98 and slider	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:43
S10 0	0	451/5,41.ccls. and (planariz\$3 with carbide)	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:44
S10 1	1	451/5,41.ccls. and (planariz\$3 with slider)	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:44
S10 2	16	S57 and (carbide or nitride)	USPAT; JPO; DERWENT	OR	ON	2005/03/01 13:49

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Kurosawa, M.; Takahashi, N.; Higuchi, T.;

Ultrasonics Symposium, 1994. Proceedings., 1994 IEEE , Volume: 1 , 1-4 Nov 1994

Pages:535 - 538 vol.1

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2 Ultrasonic linear motor using surface acoustic waves
Kurosawa, M.; Takahashi, M.; Higuchi, T.;

Ultrasonics, Ferroelectrics and Frequency Control, IEEE Transactions on , Volume: 43 , Issue: 5 , Sept. 1996

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3 Frictional behavior of magnetic recording disks
Trauner, D.; Li, Y.; Talke, F.E.;

Magnetism, IEEE Transactions on , Volume: 26 , Issue: 1 , Jan 1990

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4 Measurement of Young's modulus on microfabricated structures using surface profiler
Tai, Y.-C.; Muller, R.S.;

Micro Electro Mechanical Systems, 1990. 'Proceedings, An Investigation of Micro Structures, Sensors, Actuators, Machines and Robots'. , IEEE , 11-14 Feb. 1990

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